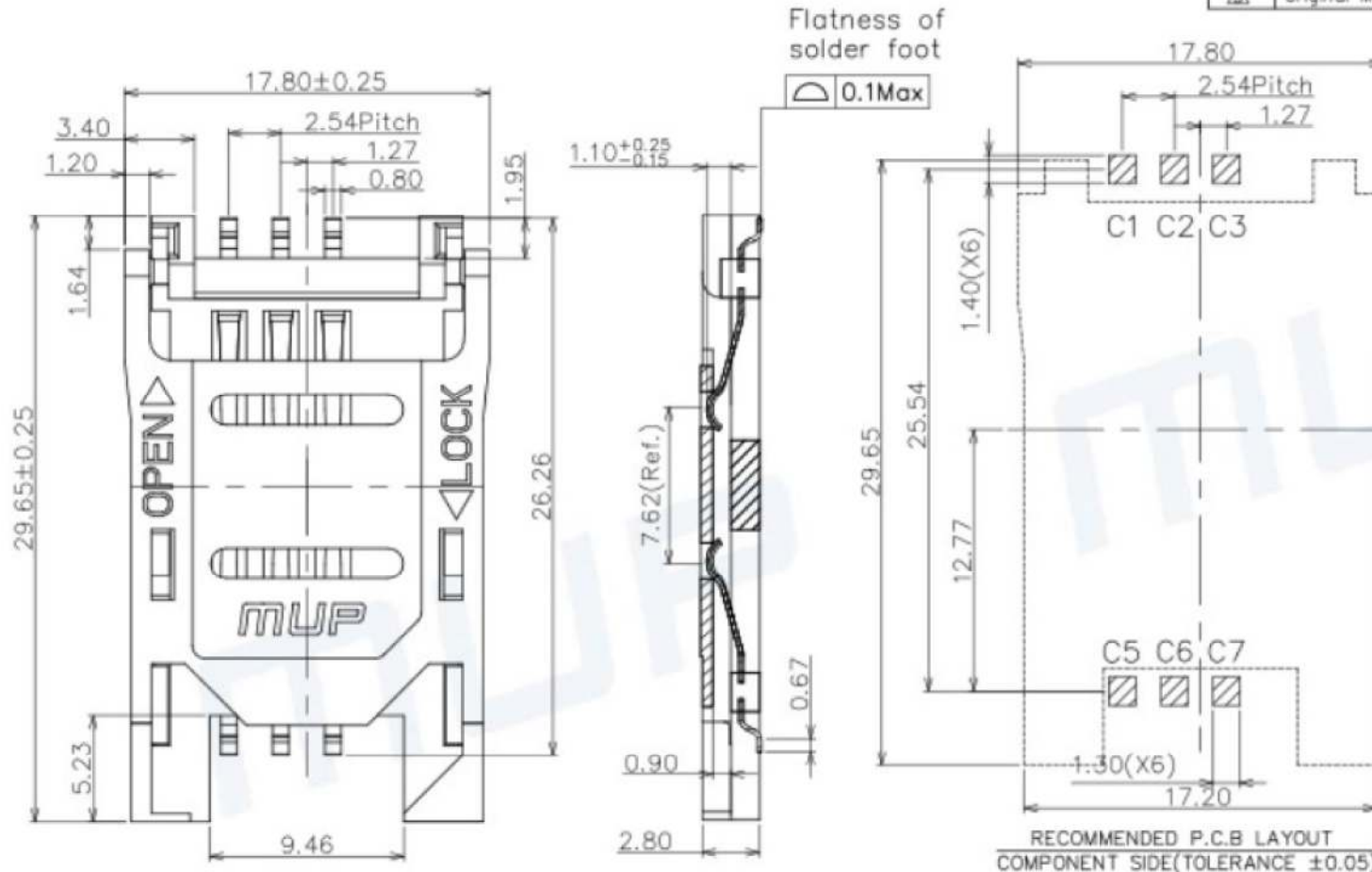
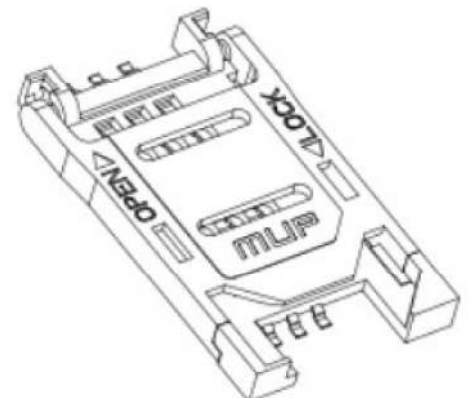


REV.	DESCRIPTION OF REVISIONS	APPR.	CHKD.	DRAW.	DATE
△	新开			huabo	2018.9.18
△	增加主体塑性变形尺寸			huabo	2020.9.17
△	Original Model C713-27			huabo	2023.10.26

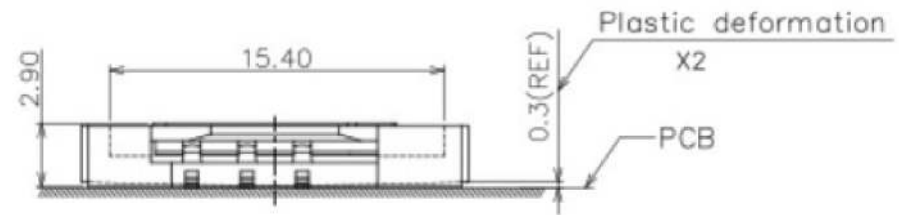


**TECHNICAL CHARACTERISTICS**

- General Characteristics  
Durability: 5,000 cycles min.
- Electrical Characteristics  
Contact resistance: Initial: 50mΩ Max.  
After Test: 100mΩ Max.  
Insulation resistance: >1000MΩ/500V DC
- Solderability  
IR reflow: 250°C, 5sec. Max  
Manual soldering: 370°C, 3sec. Max
- Environmental Characteristics  
Operating temperature: -40°C~+85°C  
Operating humidity: 10%~+95%RH



RECOMMENDED P.C.B LAYOUT  
COMPONENT SIDE(TOLERANCE ±0.05)



ITEM	PART NAME	Q'TY	MATERIAL	FINISH
1	BASE	1	Hi-temp Thermoplastic	Black UL94V-0
2	COVER	1	Hi-temp Thermoplastic	Black UL94V-0
3	DATA CONTACT	6	Copper Alloy	Contact area: 5u" Au plated

Unless otherwise specified, other tolerance are:

X	±0.35	X'	±5'
X.X	±0.25	X.X'	±4'
X.XX	±0.15	X.XX'	±3'
X.XXX	±0.10	X.XXX'	±2'

**MUP** MUP INDUSTRIAL CO.,LTD.

NAME: **SIM Card Connector**

MODEL NO: **MUP-C7013-27**

TYPE: **H2.8 without post 6p**

PROJ	UNIT	SCALE	DRAWN	HUABO	SEP.18.2018	DWG NO.:	DWG-C7013-27-01
	mm	1:1	CHECKED	Jimmy	SEP.18.2018	SHEET	1/1
CUSTOMER DRAWING			APPROVAL	Jun	SEP.18.2018	REVISION	3

